

Appl. No. 10/828,993  
Reply to Examiner's Action dated 11/29/2005

**AMENDMENTS TO THE SPECIFICATION:**

Please replace the paragraph beginning on page 6, line 6 with the following amended paragraph:

A conductive layer 13 is then formed using conventional techniques on the dielectric layer 11 (FIG. 3). The conductive layer 13 may ~~the~~ be patterned to define an RF component 10, as shown in FIGS. 4 and 5. Again, conventional lithographic and etch techniques known in the art may be used to pattern the conductive layer 13. The conductive layer may be aluminum, for example, although those of skill in the art will appreciate that other suitable conductors may be used as well. The conductive layer 13 of a typical RF component may be patterned to be an inductor or a capacitor, for example, though other circuit configurations are also possible.